

MSTBVA 2,5/ 9-GS-5,08 - PCB header



1856677

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PCB headers, nominal cross section: 2.5 mm², color: green, nominal current: 12 A, contact surface: Tin, contact connection type: Pin, number of rows: 1, number of positions: 9, product range: MSTBV 2,5/..-GS, pitch: 5.08 mm, mounting: Wave soldering, pin layout: Linear pinning, solder pin [P]: 3.9 mm, number of solder pins per potential: 1, plug-in system: COMBICON MSTB 2,5, Pin connector pattern alignment: Standard, locking: without, mounting: without, type of packaging: packed in cardboard

Your advantages

- Maximum flexibility when it comes to device design – one header for connectors with different connection technologies
- Well-known mounting principle allows worldwide use
- Vertical connection enables multi-row arrangement on the PCB
- Closed contour for optimum stability of the plug-in connection

Commercial data

Item number	1856677
Packing unit	50 pc
Minimum order quantity	1 pc
Note	Made to order (non-returnable)
Product key	AAC1DN
GTIN	4017918959845
Weight per piece (including packing)	3.39 g
Weight per piece (excluding packing)	3.39 g
Country of origin	DE

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Technical data

Product properties

Product type	PCB headers
Product family	MSTBV 2,5/..-GS
Product line	COMBICON Connectors M
Number of positions	9
Pitch	5.08 mm
Number of rows	1
Mounting flange	without
Pin layout	Linear pinning
Solder pins per potential	1

Electrical properties

Nominal current I_N	12 A
Degree of pollution	3
Rated voltage (III/3)	250 V

Mounting

Mounting type	Wave soldering
Pin layout	Linear pinning

Material specifications

Material data - contact

Note	WEEE/RoHS-compliant, free of whiskers according to IEC 60068-2-82/JEDEC JESD 201
Contact material	Cu alloy
Surface characteristics	Tin-plated
Metal surface contact area (top layer)	Tin (3 - 5 μm Sn)
Metal surface contact area (middle layer)	Nickel (1.3 - 3 μm Ni)
Metal surface soldering area (top layer)	Tin (3 - 5 μm Sn)
Metal surface soldering area (middle layer)	Nickel (1.3 - 3 μm Ni)

Material data - housing

Color ()	()
Insulating material	PA
Insulating material group	I
CTI according to IEC 60112	600
Flammability rating according to UL 94	V0
Glow wire flammability index GWFI according to EN 60695-2-12	850
Glow wire ignition temperature GWIT according to EN 60695-2-13	775
Temperature for the ball pressure test according to EN 60695-10-2	125 °C

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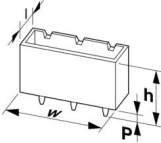
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Notes

Notes on operation	In accordance with IEC 61984, COMBICON connectors have no switching power (COC). During designated use, they must not be plugged in or disconnected when carrying voltage or under load.
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Dimensions

Dimensional drawing	
Pitch	5.08 mm
Installed height	12 mm
Solder pin length [P]	3.9 mm

Electrical tests

Air clearances and creepage distances	
Insulating material group	I
Rated insulation voltage (III/3)	250 V

Packaging specifications

Type of packaging	packed in cardboard
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Environmental product compliance

EU RoHS	
Fulfills EU RoHS substance requirements	Yes, No exemptions
China RoHS	
Environment friendly use period (EFUP)	EFUP-E
	No hazardous substances above the limits
EU REACH SVHC	
REACH candidate substance (CAS No.)	No substance above 0.1 wt%

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